



60V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

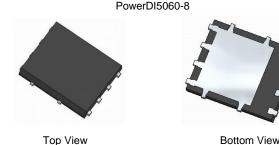
BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C (Note 5)
60V	$5.5 \text{m}\Omega$ @ V _{GS} = 10V	100A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- High-frequency switching
- Sync rectification
- DC-DC converters

Site 1:



Site 2:

PowerDI5060-8/SWP (Type UX)

Bottom View



Bottom View Top View

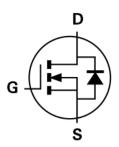
Features

- Rated to +175°C Ideal for High Ambient Temperature **Environments**
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low RDS(ON) Minimizes Power Losses
- Low Qg Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6005LPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

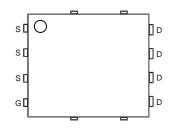
https://www.diodes.com/quality/product-definitions/

Mechanical Data

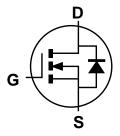
- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



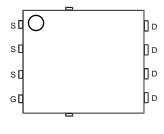
Internal Schematic



Top View Pin Configuration



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

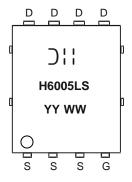
Part Number	Package	Packing		
Fait Number	Fackage	Qty.	Carrier	
DMTH6005LPSQ-13	PowerDI5060-8	2500	Tape & Reel	
DMTH6005LPSQ-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

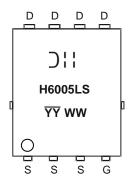
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information





☐ Manufacturer's Marking
☐ H6005LS = Product Type Marking Code
☐ YYWW = Date Code Marking
☐ YY or YY = Year (ex: 23 = 2023)
☐ WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6)	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	20.6 17.2	А
Continuous Drain Current (Note 7)	T _C = +25°C (Note 5) T _C = +100°C	lσ	100 90	А
Maximum Continuous Body Diode Forward Current (Note 7)		Is	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	160	Α
Avalanche Current, L = 1mH		las	14.8	Α
Avalanche Energy, L = 1mH		Eas	98	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P _D	3.2	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	47	°C/W
Total Power Dissipation (Note 7)	Tc = +25°C	PD	150	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

- 5. Package limited.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	60		_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	VGS(TH)	1		3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
			4.4	5.5		$V_{GS} = 10V, I_{D} = 50A$	
Static Drain-Source On-Resistance	RDS(ON)		5.7	7.2	mΩ	$V_{GS} = 6V, I_{D} = 20A$	
		_	7.7	10		$V_{GS} = 4.5V, I_D = 12.5A$	
Diode Forward Voltage	VsD	_	0.9	_	V	Vgs = 0V, Is = 50A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		2962	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	965.2	_	pF		
Reverse Transfer Capacitance	Crss		59.8	_			
Gate Resistance	Rg	_	0.66	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	47.1	_			
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	23.1	_	nC	V _{DD} = 30V, I _D = 50A	
Gate-Source Charge	Qgs	_	10.2	_	nc nc		
Gate-Drain Charge	Q_{gd}	_	12.5	_			
Turn-On Delay Time	t _D (ON)	_	8.3	_			
Turn-On Rise Time	t _R	_	9.4	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 30A, R_{G} = 3.3\Omega$	
Turn-Off Delay Time	tD(OFF)	_	22	_	ns		
Turn-Off Fall Time	tF	_	8.9	_			
Body Diode Reverse-Recovery Time	trr		40.4	_	ns	I 200 di/dt 4000//	
Body Diode Reverse-Recovery Charge	Qrr		49.7		nC	IF = 30A, di/dt = 100A/μs	

Notes: 8. Short duration pulse test used to minimize self-heating effect.

^{9.} Guaranteed by design. Not subject to product testing.



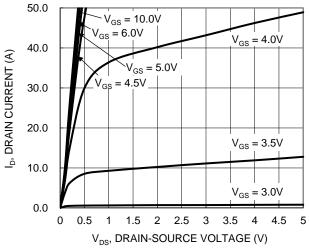


Figure 1. Typical Output Characteristic

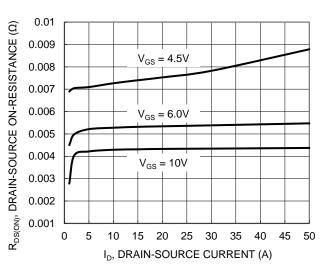


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

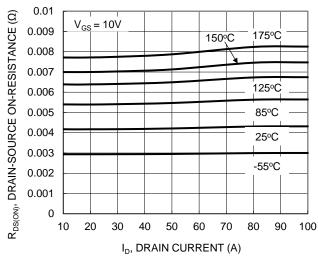


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

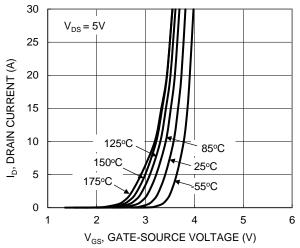


Figure 2. Typical Transfer Characteristic

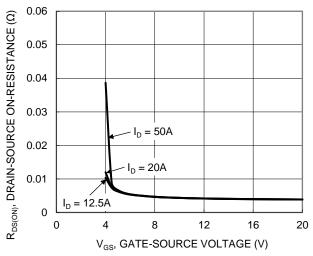


Figure 4. Typical Transfer Characteristic

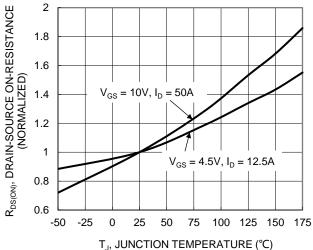


Figure 6. On-Resistance Variation with Junction Temperature



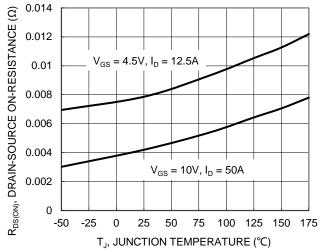


Figure 7. On-Resistance Variation with Junction Temperature

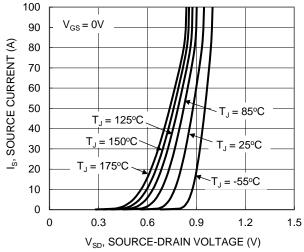


Figure 9. Diode Forward Voltage vs. Current

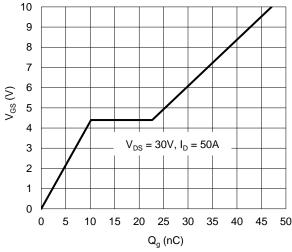


Figure 11. Gate Charge

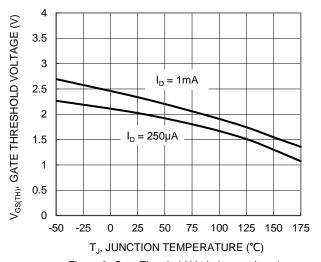


Figure 8. Gate Threshold Variation vs. Junction Temperature

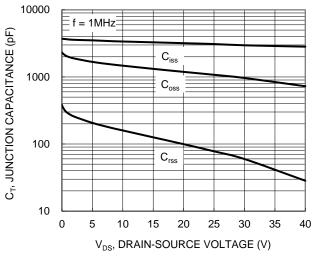


Figure 10. Typical Junction Capacitance

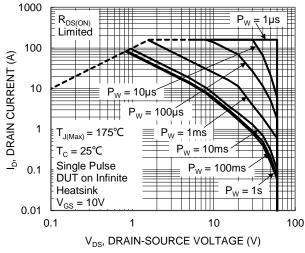


Figure 12. SOA, Safe Operation Area



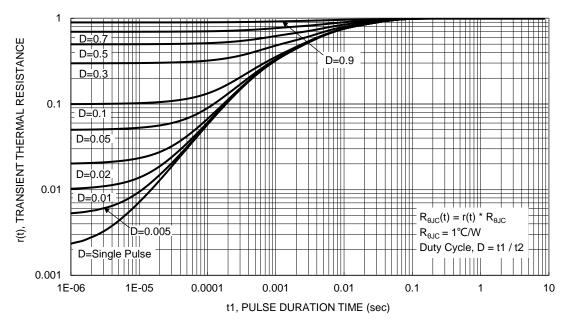


Figure 13. Transient Thermal Resistance

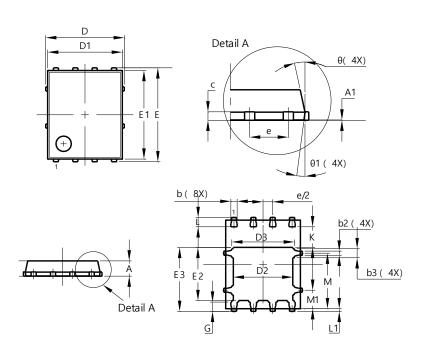


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

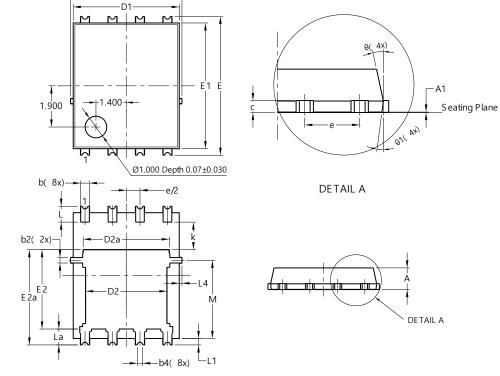
PowerDI5060-8



PowerDI5060-8				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
D		5.15 BSC		
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
E	(6.15 BSC	;	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC		
G	0.51	0.71	0.61	
K	0.51	-	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
M	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

Site 2:

PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP				
(Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4).25REF		
С	0.230	0.330	0.277	
D	5	.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6.40 BSC			
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
M	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

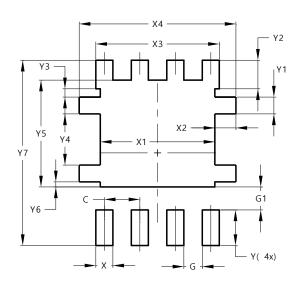


Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

Site 1:

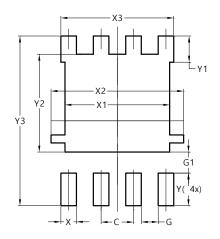
PowerDI5060-8



Dimensions	Value (in mm)	
С	1.270	
G	0.660	
G1	0.820	
Х	0.610	
X1	4.100	
X2	0.755	
Х3	4.420	
X4	5.610	
Υ	1.270	
Y1	0.600	
Y2	1.020	
Y3	0.295	
Y4	1.825	
Y5	3.810	
Y6	0.180	
Y7	6.610	

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value	
	(in mm)	
С	1.270	
G	0.660	
G1	0.820	
Χ	0.610	
X1	4.100	
X2	5.190	
Х3	4.420	
Υ	1.270	
Y1	1.020	
Y2	3.810	
Y3	6.610	



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